May 2010



SEMICONDUCTOR

# FGH60N60SMD 600V, 60A Field Stop IGBT

## **Features**

- Maximum Junction Temperature : T<sub>J</sub> =175°C
- Positive Temperaure Co-efficient for easy parallel operating
- High current capability •
- Low saturation voltage: V<sub>CE(sat)</sub> =1.9V(Typ.) @ I<sub>C</sub> = 60A •
- · High input impedance
- Fast switching
- Tighten Parameter Distribution
- · RoHS compliant

# Applications

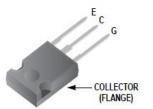
- Solar Inverter, UPS, SMPS, PFC •
- Induction Heating •

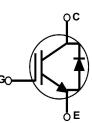




# **General Description**

Using Novel Field Stop IGBT Technology, Fairchild's new series of Field Stop IGBTs offer the optimum performance for Solar Inverter, UPS, SMPS, IH and PFC applications where low conduction and switching losses are essential.





### **Absolute Maximum Ratings**

Symbol	Description	1	Ratings	Units
V <sub>CES</sub>	Collector to Emitter Voltage		600	V
V <sub>GES</sub>	Gate to Emitter Voltage		± 20	V
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 25°C	120	A
	Collector Current	@ T <sub>C</sub> = 100°C	60	A
I <sub>CM (1)</sub>	Pulsed Collector Current		180	A
I <sub>F</sub>	Diode Forward Current	@ T <sub>C</sub> = 25°C	60	A
·r	Diode Forward Current	@ T <sub>C</sub> = 100°C	30	А
I <sub>FM (1)</sub>	Pulsed Diode Maximum Forward Current		180	A
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	600	W
· D	Maximum Power Dissipation	@ T <sub>C</sub> = 100°C	300	W
TJ	Operating Junction Temperature		-55 to +175	°C
T <sub>stg</sub>	Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Notes: 1: Repetitive rating: Pulse width limited by max. junction temperature

Symbol Paramete		r		Туј	0.	Max.	Units			
$\begin{tabular}{lllllllllllllllllllllllllllllllllll$				0.25		°C/W				
								$R_{ hetaJA}$	Therr	mal Resistance, Junctio
Packag	e Marki	ing and Orderi	ng In	formatio	on					
Device N	Marking	Device	Pa	ckage Reel Size		Таре	Tape Width		antity	
FGH60N	60SMD	FGH60N60SMD	٦	0-247	0-247 -		-		30	
Electric	al Cha	racteristics of	the IC	GBT <sub>Tc=2</sub>	5°C unless othe	erwise noted				
Symbol Parameter			Test	Conditio	ons	Min.	Тур.	Max.	Units	
Off Charac	toristics			•			1			
BV <sub>CES</sub>	1	to Emitter Breakdown \	/oltage	V <sub>GE</sub> = 0V. 1/	s = 250µA		600	-	-	V
$\frac{\Delta BV_{CES}}{\Delta T_{J}}$	-	Collector to Emitter Breakdown Voltage Temperature Coefficient of Breakdown Voltage		$V_{GE} = 0V, I_{C} = 250\mu A$ $V_{GE} = 0V, I_{C} = 250\mu A$		-	0.6	-	V/ºC	
I <sub>CES</sub>	-			V <sub>CE</sub> = V <sub>CES</sub>	V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0V		-	-	250	μA
I <sub>GES</sub>	G-E Leak	-E Leakage Current		$V_{GE} = V_{GES}, V_{CE} = 0V$		-	-	±400	nA	
On Charac	toristics									
V <sub>GE(th)</sub>	G-E Threshold Voltage		I <sub>C</sub> = 250μA, V <sub>CE</sub> = V <sub>GE</sub>			3.5	4.5	6.0	V	
GE(th)				$I_{\rm C} = 60$ A, $V_{\rm GE} = 15$ V		-	1.9	2.5	v	
V <sub>CE(sat)</sub>	Collector	ollector to Emitter Saturation Voltage		$I_{C} = 60A, V_{GE} = 15V,$ $T_{C} = 175^{\circ}C$		-	2.1	-	V	
Dynamic C	haracteris	tics		0						
C <sub>ies</sub>	Input Cap			V <sub>CE</sub> = 30V, V <sub>GE</sub> = 0V, f = 1MHz			-	2915	-	pF
C <sub>oes</sub>		apacitance					-	270	-	pF
C <sub>res</sub>	Reverse 7	Reverse Transfer Capacitance					-	85	-	pF
Switching	Characteri	ation								
t <sub>d(on)</sub>		Delay Time					_	18	27	ns
t.	Rise Time	5		-			-	47	70	ns
t <sub>d(off)</sub>		Delay Time		$V_{00} = 400V$	lo = 60A		-	104	146	ns
t <sub>f</sub>	Fall Time			$V_{CC}$ = 400V, $I_C$ = 60A, R <sub>G</sub> = 3 $\Omega$ , $V_{GE}$ = 15V, Inductive Load, $T_C$ = 29		_	-	50	68	ns
E <sub>on</sub>	Turn-On S	Switching Loss				5ºC	-	1.26	1.94	mJ
E <sub>off</sub>		Switching Loss					-	0.45	0.6	mJ
E <sub>ts</sub>		ching Loss		1			-	1.71	2.54	mJ
t <sub>d(on)</sub>	Turn-On [	Delay Time					-	18	-	ns
t <sub>r</sub>	Rise Time	9		1			-	41	-	ns
t <sub>d(off)</sub>	Turn-Off [	Delay Time		V <sub>CC</sub> = 400V	, I <sub>C</sub> = 60A.		-	115	-	ns
t <sub>f</sub>	Fall Time			$V_{CC} = 400V, I_{C} = 60A,$ $R_{G} = 3\Omega, V_{GE} = 15V,$		0 -	-	48	-	ns
E <sub>on</sub>	Turn-On S	Switching Loss		Inductive Lo	ad, T <sub>C</sub> = 17	′5°C	-	2.1	-	mJ
E <sub>off</sub>	Turn-Off S	Switching Loss		1			-	0.78	-	mJ
E <sub>ts</sub>	Total Swit	ahina Lasa		-			_	2.88	-	mJ

# Electrical Characteristics of the IGBT (Continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Units
Qg	Total Gate Charge		-	189	284	nC
Q <sub>ge</sub>	Gate to Emitter Charge	V <sub>CE</sub> = 400V, I <sub>C</sub> = 60A, V <sub>GE</sub> = 15V	-	20	30	nC
Q <sub>gc</sub>	Gate to Collector Charge	VGE - 13V	-	91	137	nC

# Electrical Characteristics of the Diode $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Condition	าร	Min.	Тур.	Max	Units
V <sub>FM</sub>	Diode Forward Voltage	I <sub>F</sub> = 30A	T <sub>C</sub> = 25°C	-	2.1	2.7	V
			T <sub>C</sub> = 175°C	-	1.7	-	
E <sub>rec</sub>	Reverse Recovery Energy		T <sub>C</sub> = 175 <sup>o</sup> C	-	0.68	-	mJ
t	Diode Reverse Recovery Time	I <sub>F</sub> =30A, dI <sub>F</sub> /dt = 200A/μs	T <sub>C</sub> = 25 <sup>o</sup> C	-	30	39	ns
۲rr		$1F = 30A, 0F = 200A/\mu 3$	T <sub>C</sub> = 175 <sup>o</sup> C	-	72	-	110
Q <sub>rr</sub>	Diode Reverse Recovery Charge		T <sub>C</sub> = 25 <sup>o</sup> C	-	44	62	nC
	block hover to block hovery charge		T <sub>C</sub> = 175 <sup>o</sup> C	-	238	-	

# **Typical Performance Characteristics**

**Figure 1. Typical Output Characteristics** 

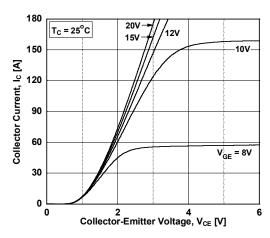


Figure 3. Typical Saturation Voltage Characteristics

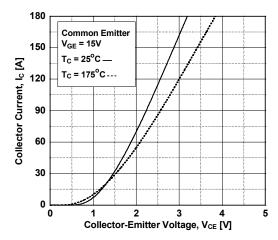
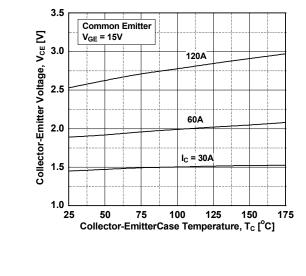
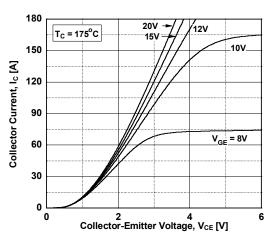


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level



**Figure 2. Typical Output Characteristics** 



**Figure 4. Transfer Characteristics** 

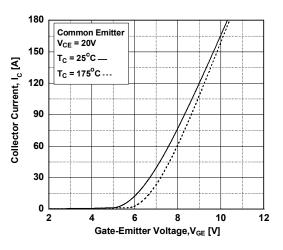
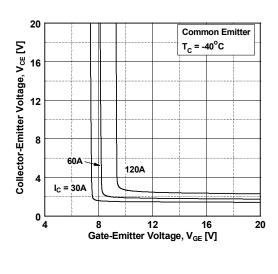
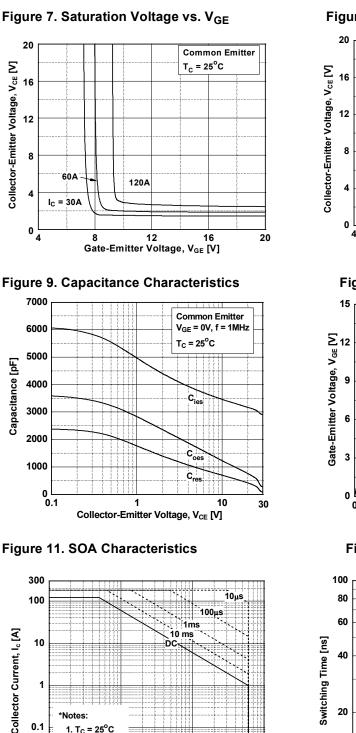


Figure 6. Saturation Voltage vs. V<sub>GE</sub>





**Typical Performance Characteristics** 

## Figure 8. Saturation Voltage vs. V<sub>GE</sub>

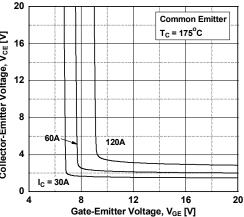


Figure 10. Gate charge Characteristics

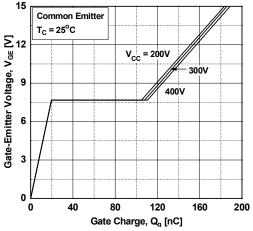
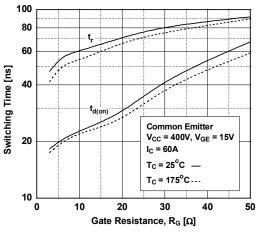


Figure 12. Turn-on Characteristics vs. **Gate Resistance** 



1

0.1

0.01

1

\*Notes:

1. T<sub>C</sub> = 25<sup>o</sup>C

2.  $T_J = 175^{\circ}C$ 

3. Single Pulse

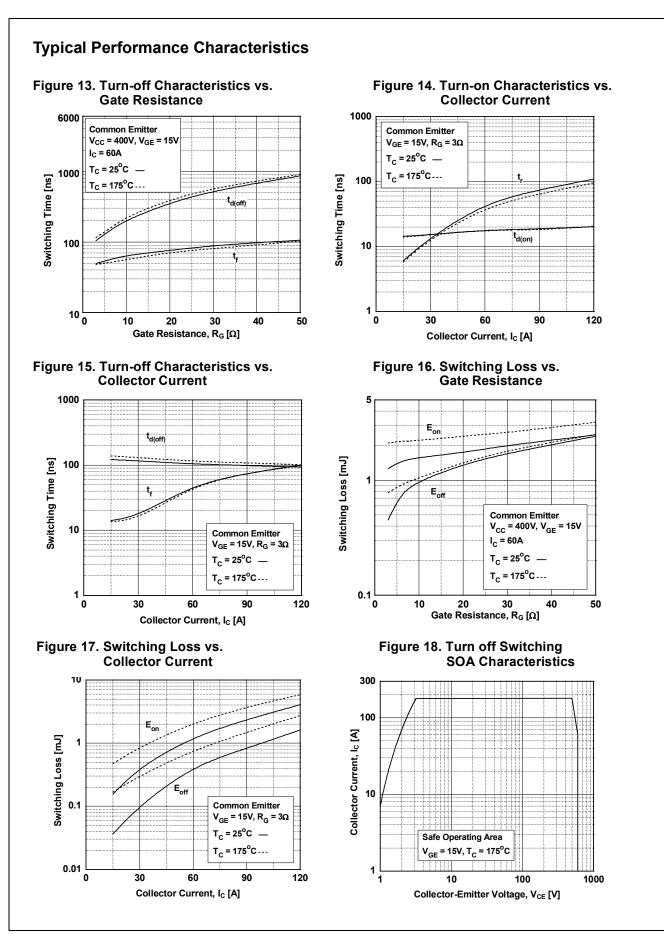
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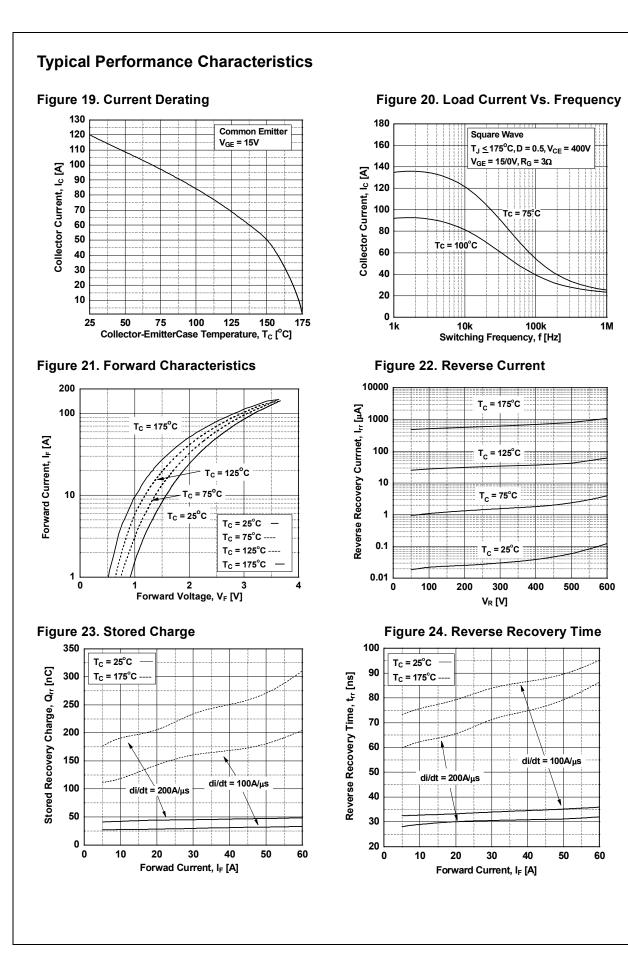
100

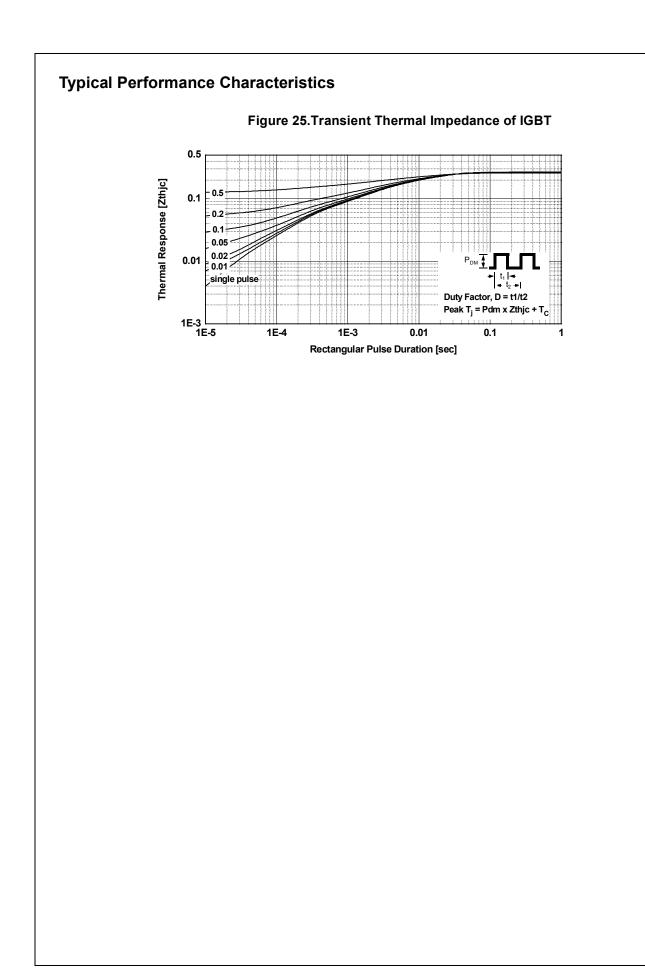
Collector-Emitter Voltage, V<sub>CE</sub> [V]

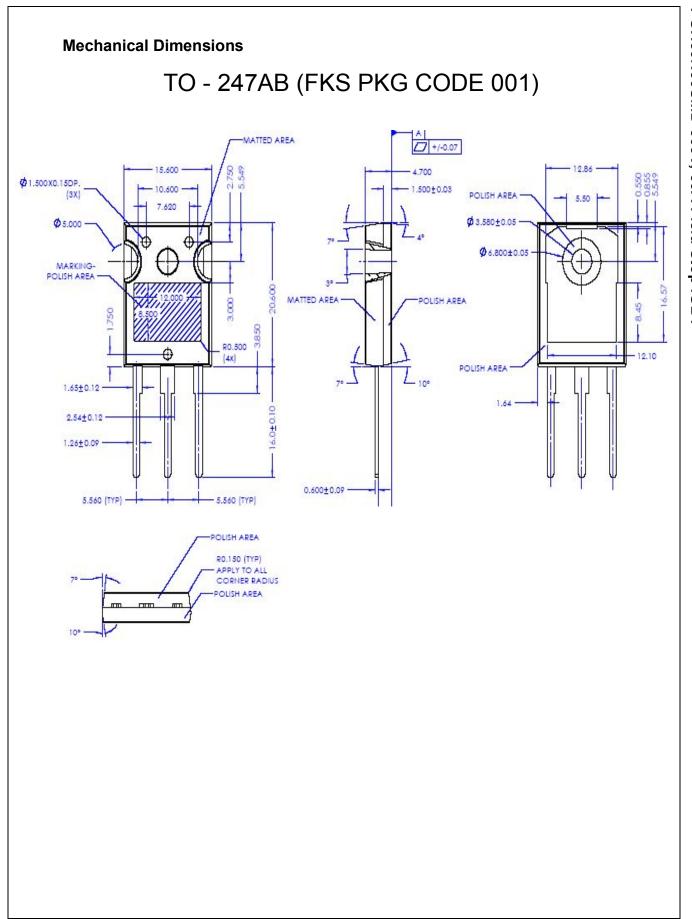
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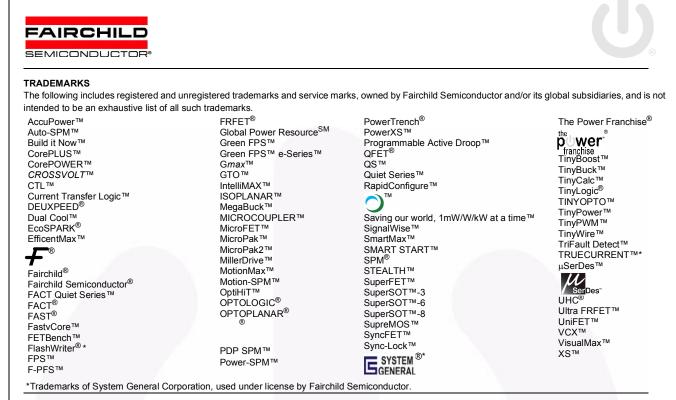








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